

| Absolute Maximum Ratings           |                                                       | Values             | Units            |
|------------------------------------|-------------------------------------------------------|--------------------|------------------|
| Symbol                             | Conditions <sup>1)</sup>                              |                    |                  |
| V <sub>CES</sub>                   |                                                       | 600                | V                |
| V <sub>CGR</sub>                   | R <sub>GE</sub> = 20 kΩ                               | 600                | V                |
| I <sub>C</sub>                     | T <sub>case</sub> = 25/70 °C                          | 130 / 100          | A                |
| I <sub>CM</sub>                    | T <sub>case</sub> = 25/70 °C; t <sub>p</sub> = 1 ms   | 150 / 150          | A                |
| V <sub>GES</sub>                   |                                                       | ± 20               | V                |
| P <sub>tot</sub>                   | per IGBT, T <sub>case</sub> = 25 °C                   | 450                | W                |
| T <sub>J</sub> , T <sub>stg</sub>  |                                                       | −40 ... +150 (125) | °C               |
| V <sub>isol</sub>                  | AC, 1 min.                                            | 2500               | V                |
| humidity                           | DIN 40040                                             | Class F            |                  |
| climate                            | DIN IEC 68 T.1                                        | 40/125/56          |                  |
| Inverse Diode                      |                                                       |                    |                  |
| I <sub>F</sub> = −I <sub>C</sub>   | T <sub>case</sub> = 25/80 °C                          | 100 / 75           | A                |
| I <sub>FM</sub> = −I <sub>CM</sub> | T <sub>case</sub> = 25/80 °C; t <sub>p</sub> = 1 ms   | 260 / 200          | A                |
| I <sub>FSM</sub>                   | t <sub>p</sub> = 10 ms; sin.; T <sub>J</sub> = 150 °C | 720                | A                |
| I <sup>2</sup> t                   | t <sub>p</sub> = 10 ms; T <sub>J</sub> = 150 °C       | 2600               | A <sup>2</sup> s |

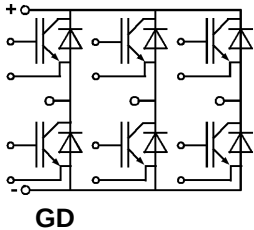
| Characteristics                  |                                                               | min.               | typ.       | max.     | Units |
|----------------------------------|---------------------------------------------------------------|--------------------|------------|----------|-------|
| Symbol                           | Conditions <sup>1)</sup>                                      |                    |            |          |       |
| V <sub>(BR)CES</sub>             | V <sub>GE</sub> = 0, I <sub>C</sub> = 3 mA                    | ≥ V <sub>CES</sub> | —          | —        | V     |
| V <sub>GE(th)</sub>              | V <sub>GE</sub> = V <sub>CE</sub> , I <sub>C</sub> = 2 mA     | 4,5                | 5,5        | 6,5      | V     |
| I <sub>CES</sub>                 | V <sub>GE</sub> = 0 } T <sub>J</sub> = 25 °C                  | —                  | 0,2        | 3        | mA    |
|                                  | V <sub>CE</sub> = V <sub>CES</sub> } T <sub>J</sub> = 125 °C  | —                  | 5          | —        | mA    |
| I <sub>GES</sub>                 | V <sub>GE</sub> = 20 V, V <sub>CE</sub> = 0                   | —                  | —          | 200      | nA    |
| V <sub>CESat</sub>               | I <sub>C</sub> = 75 A } V <sub>GE</sub> = 15 V;               | —                  | 1,8(2,0)   | —        | V     |
| V <sub>CESat</sub>               | I <sub>C</sub> = 100 A } T <sub>J</sub> = 25 (125) °C }       | —                  | 2,1(2,4)   | 2,5(2,8) | V     |
| g <sub>fs</sub>                  | V <sub>CE</sub> = 20 V, I <sub>C</sub> = 100 A                | 30                 | —          | —        | S     |
| C <sub>CHC</sub>                 | per IGBT                                                      | —                  | —          | 350      | pF    |
| C <sub>ies</sub>                 | V <sub>GE</sub> = 0                                           | —                  | 5600       | —        | pF    |
| C <sub>oes</sub>                 | V <sub>CE</sub> = 25 V                                        | —                  | 600        | —        | pF    |
| C <sub>res</sub>                 | f = 1 MHz                                                     | —                  | 400        | —        | pF    |
| L <sub>CE</sub>                  |                                                               | —                  | —          | 60       | nH    |
| t <sub>d(on)</sub>               | V <sub>CC</sub> = 300 V                                       | —                  | 50         | —        | ns    |
| t <sub>r</sub>                   | V <sub>GE</sub> = −15 V / +15 V <sup>3)</sup>                 | —                  | 40         | —        | ns    |
| t <sub>d(off)</sub>              | I <sub>C</sub> = 100 A, ind. load                             | —                  | 300        | —        | ns    |
| t <sub>f</sub>                   | R <sub>Gon</sub> = R <sub>Goff</sub> = 10 Ω                   | —                  | 35         | —        | ns    |
| E <sub>on</sub>                  | T <sub>J</sub> = 125 °C                                       | —                  | 4          | —        | mWs   |
| E <sub>off</sub>                 |                                                               | —                  | 3          | —        | mWs   |
| Inverse Diode <sup>8)</sup>      |                                                               |                    |            |          |       |
| V <sub>F</sub> = V <sub>EC</sub> | I <sub>F</sub> = 75 A } V <sub>GE</sub> = 0 V;                | —                  | 1,45(1,35) | 1,7      | V     |
| V <sub>F</sub> = V <sub>EC</sub> | I <sub>F</sub> = 100A } T <sub>J</sub> = 25 (125) °C }        | —                  | 1,55(1,55) | 1,9      | V     |
| V <sub>TO</sub>                  | T <sub>J</sub> = 125 °C                                       | —                  | —          | 0,9      | V     |
| r <sub>t</sub>                   | T <sub>J</sub> = 125 °C                                       | —                  | 8          | 11       | mΩ    |
| I <sub>RRM</sub>                 | I <sub>F</sub> = 100 A; T <sub>J</sub> = 125 °C <sup>2)</sup> | —                  | 44         | —        | A     |
| Q <sub>rr</sub>                  | I <sub>F</sub> = 100 A; T <sub>J</sub> = 125 °C <sup>2)</sup> | —                  | 6,0        | —        | μC    |
| Thermal characteristics          |                                                               |                    |            |          |       |
| R <sub>thjc</sub>                | per IGBT                                                      | —                  | —          | 0,27     | °C/W  |
| R <sub>thjc</sub>                | per diode                                                     | —                  | —          | 0,6      | °C/W  |
| R <sub>thch</sub>                | per module                                                    | —                  | —          | 0,05     | °C/W  |

## SEMITRANS® Sixpack Superfast IGBT Modules

SKM 100 GD 063 DL \*)



Sixpack



### Features

- MOS input (voltage controlled)
- N channel, homogeneous Si-structure (NPT-IGBT)
- High short circuit capability, self limiting to 6 \* I<sub>cnom</sub>
- Fast & soft invese CAL diodes <sup>8)</sup>
- Isolated copper baseplate using DCB Direct Copper Bonding Technology without hard mould
- Large clearance (9 mm) and creepage distances (13 mm)

### Typical Applications

- Switched mode power supplies
- Three phase inverters for AC motor speed control
- Pulse frequencies also above 10 kHz

<sup>1)</sup> T<sub>case</sub> = 25 °C, unless otherwise specified

<sup>2)</sup> I<sub>F</sub> = − I<sub>C</sub>, V<sub>R</sub> = 300 V, −di<sub>F</sub>/dt = 1000 A/μs, V<sub>GE</sub> = 0 V

<sup>3)</sup> Use V<sub>GEoff</sub> = −5... −15 V

<sup>8)</sup> CAL = Controlled Axial Lifetime Technology.

Cases and mech. data → B 6 – 32  
Sixpack

\*) Main terminals round 2 mm dia

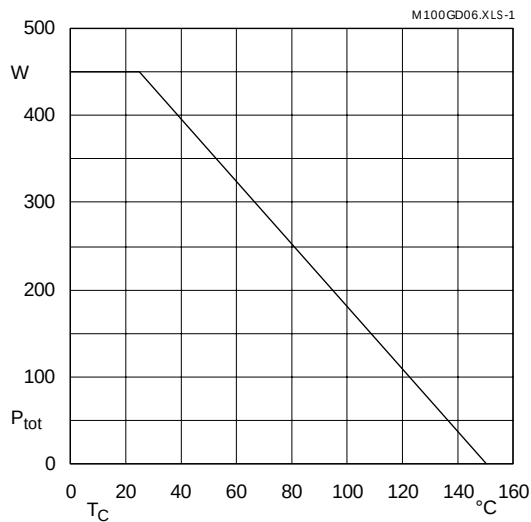


Fig. 1 Rated power dissipation  $P_{tot} = f(T_C)$

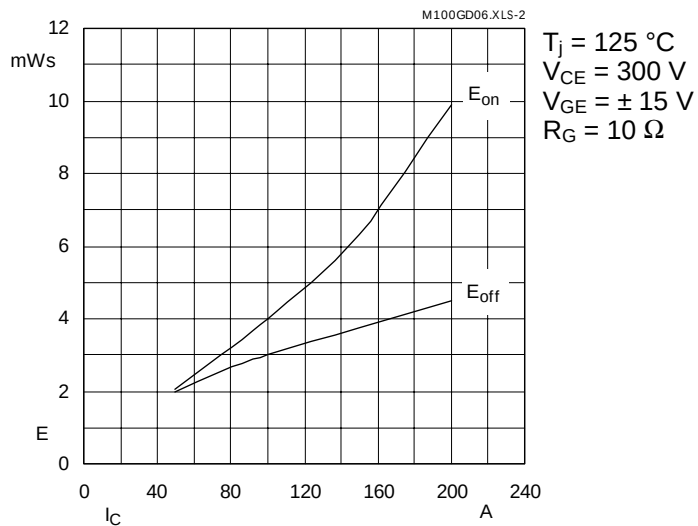


Fig. 2 Turn-on /-off energy  $= f(I_C)$

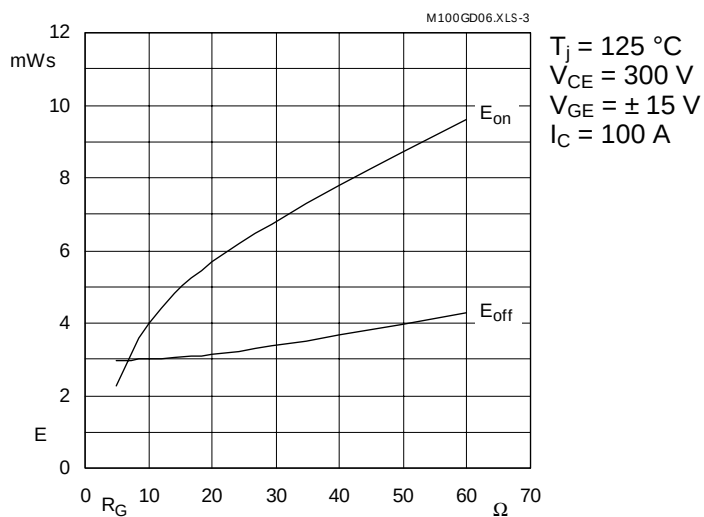


Fig. 3 Turn-on /-off energy  $= f(R_G)$

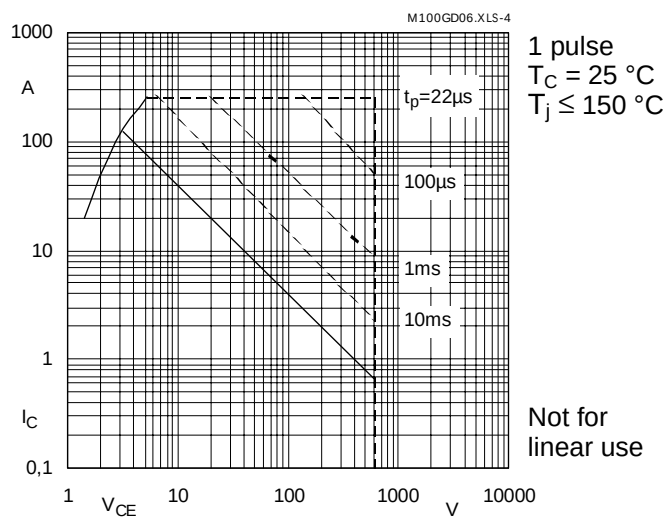


Fig. 4 Maximum safe operating area (SOA)  $I_C = f(V_{CE})$

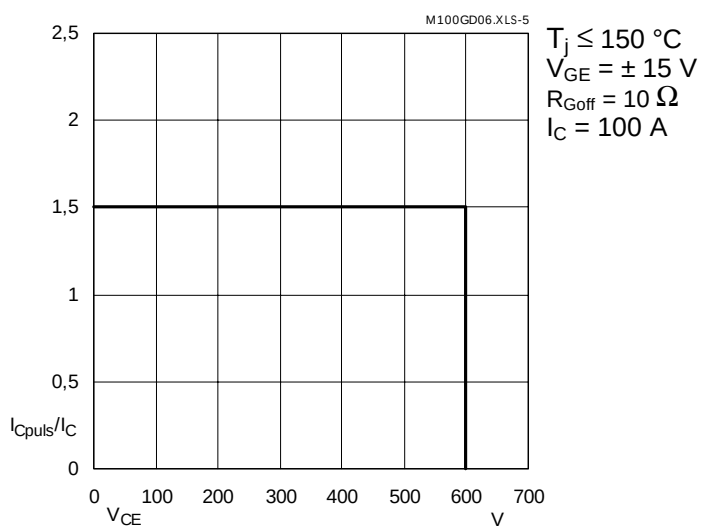


Fig. 5 Turn-off safe operating area (RBSOA)

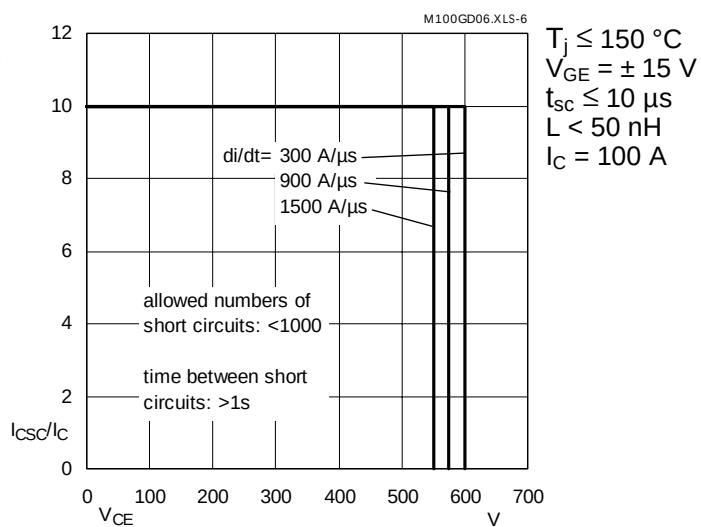


Fig. 6 Safe operating area at short circuit  $I_C = f(V_{CE})$

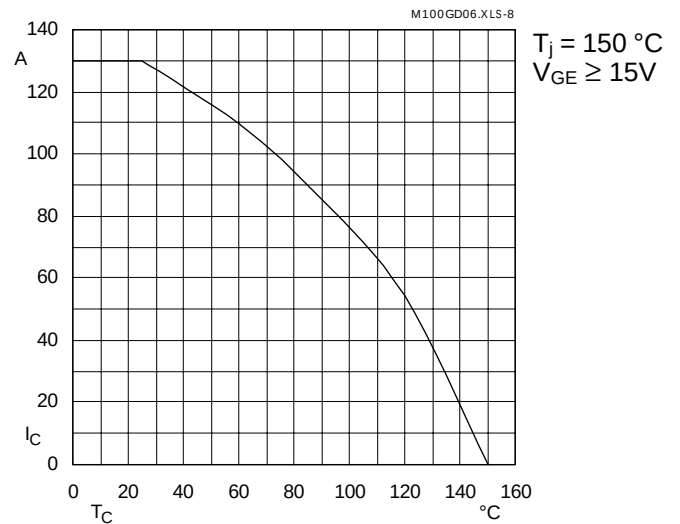


Fig. 8 Rated current vs. temperature  $I_C = f(T_C)$

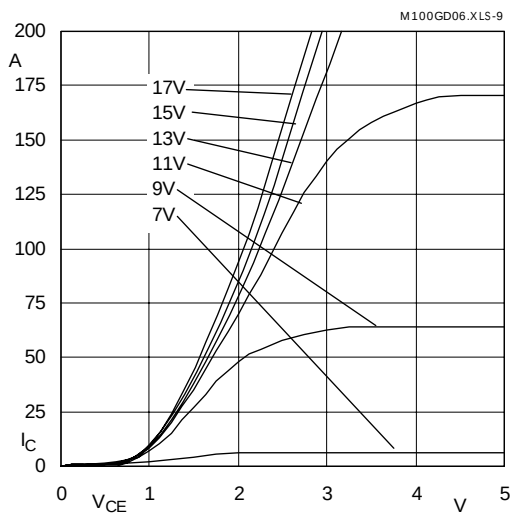


Fig. 9 Typ. output characteristic,  $t_p = 250 \mu s$ ;  $T_J = 25 \text{ }^\circ\text{C}$

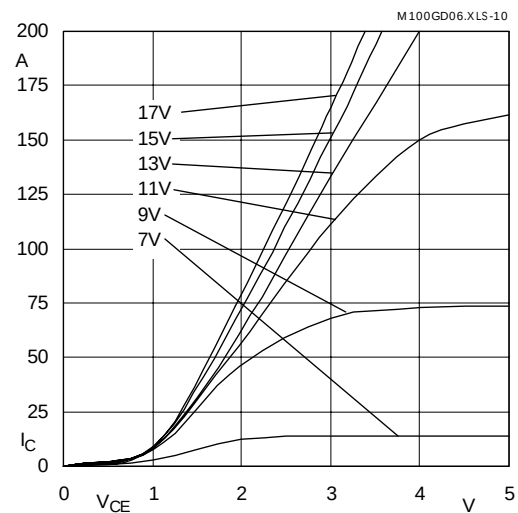


Fig. 10 Typ. output characteristic,  $t_p = 250 \mu s$ ;  $T_J = 125 \text{ }^\circ\text{C}$

$$P_{\text{cond}(t)} = V_{\text{CEsat}(t)} \cdot I_{\text{C}(t)}$$

$$V_{\text{CEsat}(t)} = V_{\text{CE(TO)(T}_J)} + r_{\text{CE(T}_J)} \cdot I_{\text{C}(t)}$$

$$V_{\text{CE(TO)(T}_J)} \leq 1,2 - 0,001 (T_J - 25) [\text{V}]$$

$$\text{typ.: } r_{\text{CE(T}_J)} = 0,0090 + 0,00004 (T_J - 25) [\Omega]$$

$$\text{max.: } r_{\text{CE(T}_J)} = 0,013 + 0,00004 (T_J - 25) [\Omega]$$

$$\text{valid for } V_{\text{GE}} = +15 \pm 2 \text{ V}; I_{\text{C}} \geq 0,3 I_{\text{Cn}}$$

Fig. 11 Saturation characteristic (IGBT)  
Calculation elements and equations

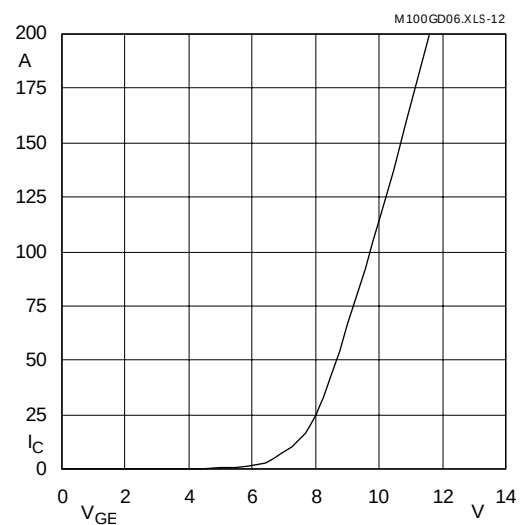


Fig. 12 Typ. transfer characteristic,  $t_p = 250 \mu s$ ;  $V_{\text{CE}} = 20 \text{ V}$

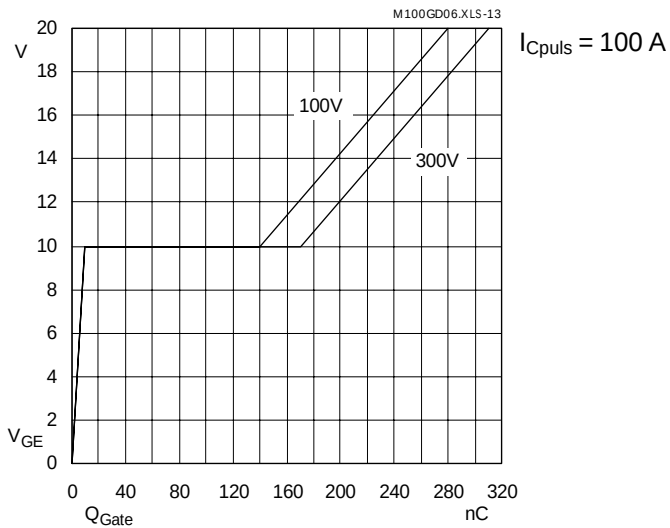


Fig. 13 Typ. gate charge characteristic

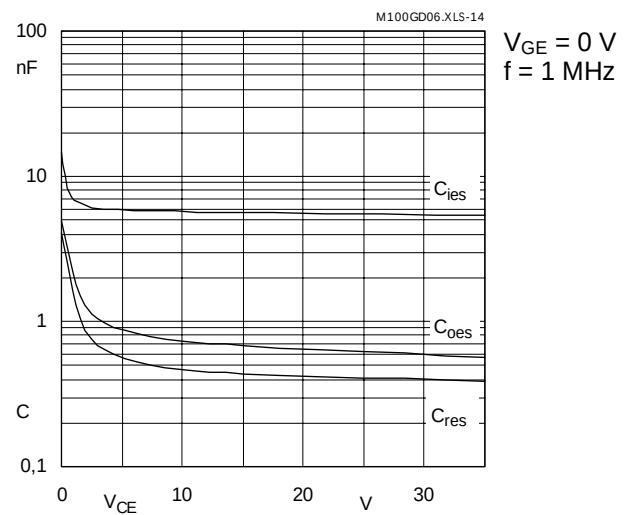


Fig. 14 Typ. capacitances vs.  $V_{CE}$

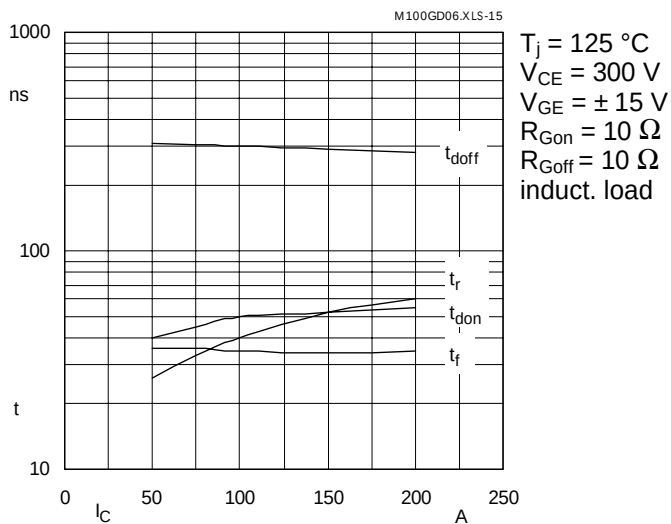


Fig. 15 Typ. switching times vs.  $I_C$

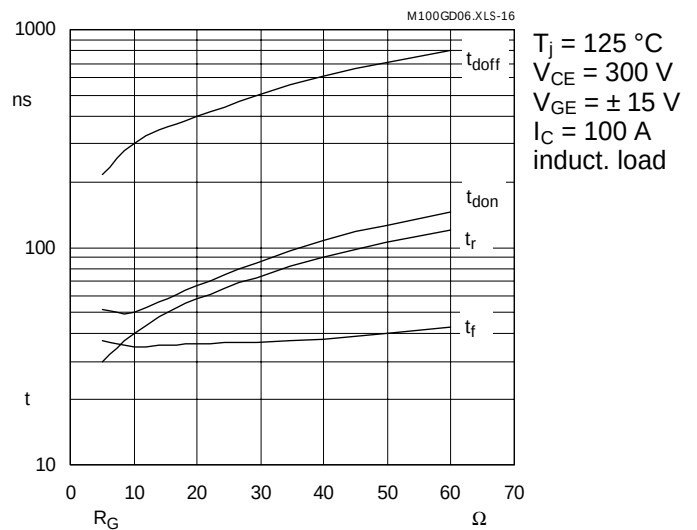


Fig. 16 Typ. switching times vs. gate resistor  $R_G$

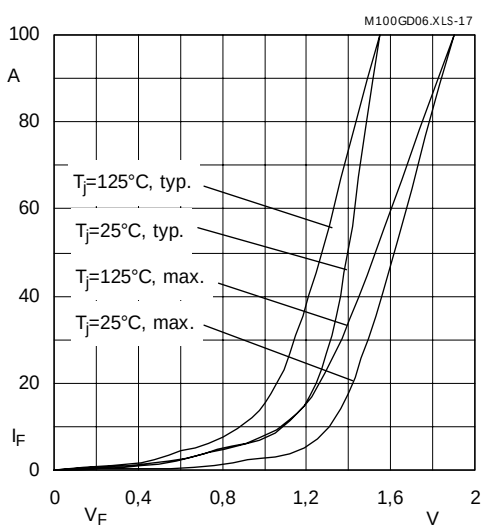


Fig. 17 Typ. CAL diode forward characteristic

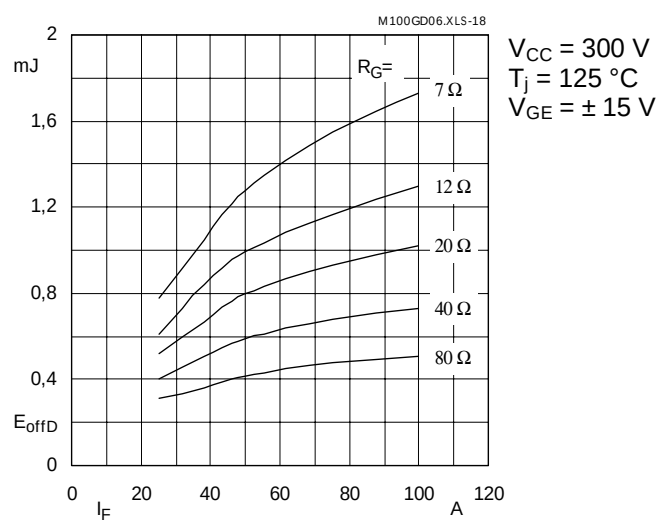


Fig. 18 Diode turn-off energy dissipation per pulse

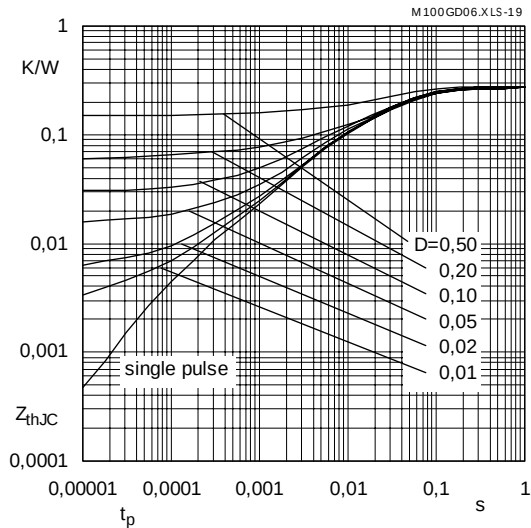


Fig. 19 Transient thermal impedance of IGBT  
 $Z_{thJC} = f(t_p)$ ;  $D = t_p / t_c = t_p \cdot f$

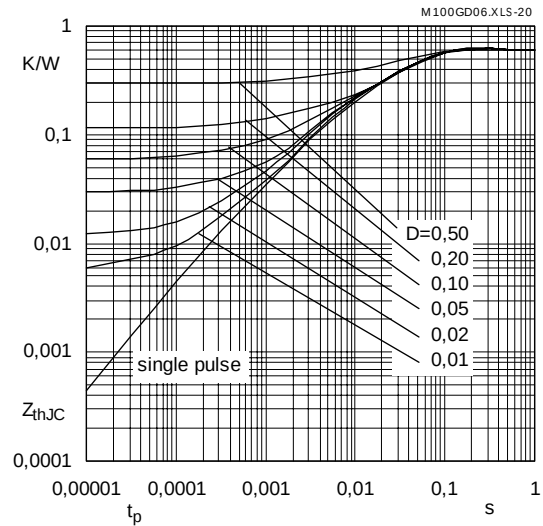


Fig. 20 Transient thermal impedance of inverse CAL diodes  $Z_{thJC} = f(t_p)$ ;  $D = t_p / t_c = t_p \cdot f$

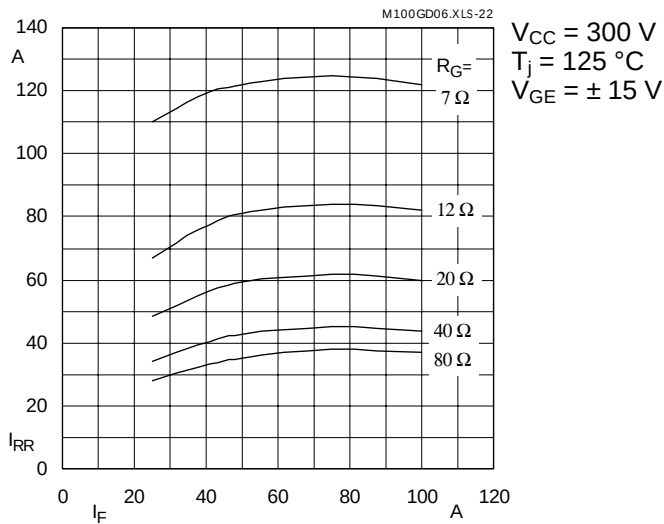


Fig. 22 Typ. CAL diode peak reverse recovery current  $I_{RR} = f(I_F; R_G)$

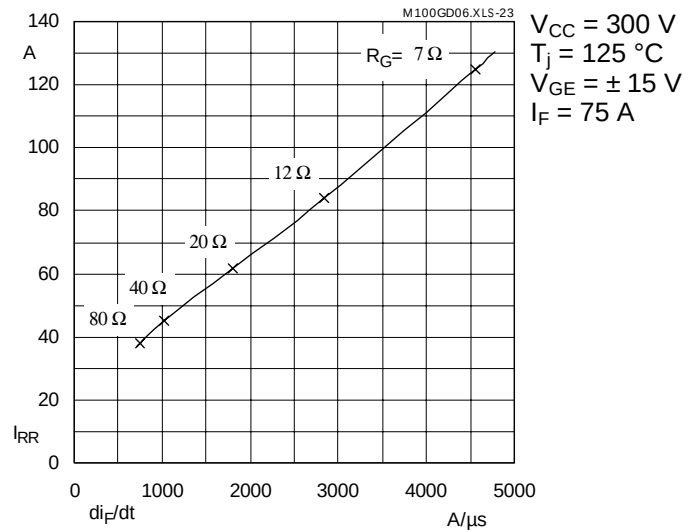


Fig. 23 Typ. CAL diode peak reverse recovery current  $I_{RR} = f(di_F/dt)$

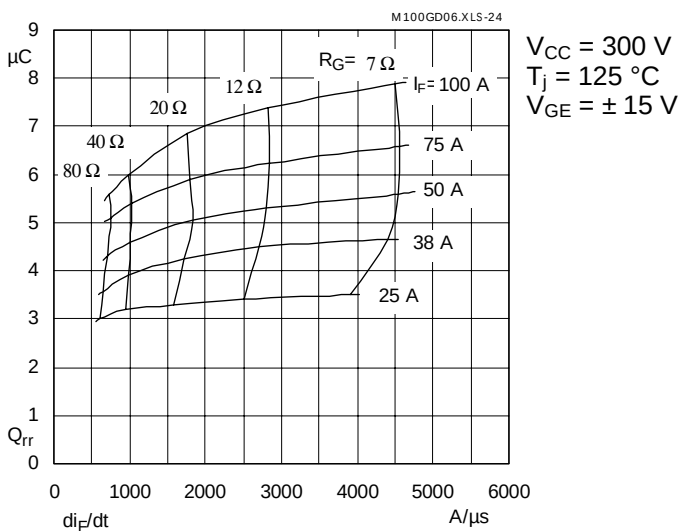


Fig. 24 Typ. CAL diode recovered charge

# SKM 100 GD 063 D...

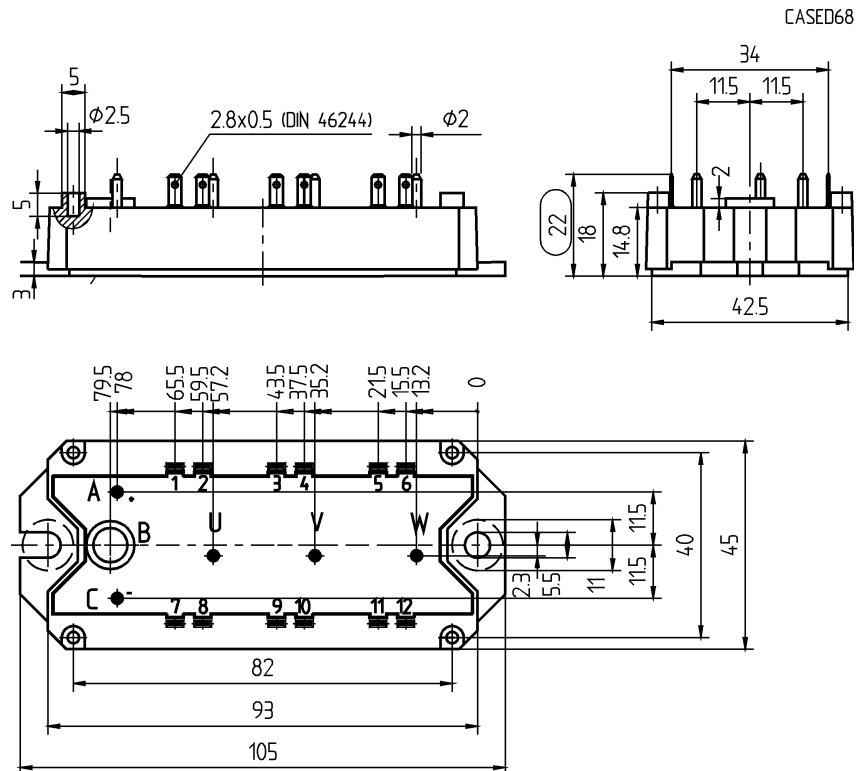
## SEMITRANS® Sixpack

Case D 68

UL Recognized

File no. E 63 532

**SKM 100 GD 063 DL**



Dimensions in mm

## Case outline and circuit diagram

| Mechanical Data |                            |        |      |        |                  |
|-----------------|----------------------------|--------|------|--------|------------------|
| Symbol          | Conditions                 | Values |      |        | Units            |
|                 |                            | min.   | typ. | max.   |                  |
| M <sub>1</sub>  | to heatsink, SI Units (M5) | 4      | –    | 5      | Nm               |
|                 | to heatsink, US Units      | 35     | –    | 44     | lb.in.           |
| a               |                            | –      | –    | 5x9,81 | m/s <sup>2</sup> |
| w               |                            | –      | –    | 175    | g                |

**This is an electrostatic discharge sensitive device (ESDS). Please observe the international standard IEC 747-1, Chapter IX.**

Two devices are supplied in one SEMIBOX A.  
Larger packing units (for 10 and 20 pieces) are used if suitable  
SEMIBOX → C - 1.